

### 100 V - 5 A DPAK power Schottky trench rectifier





### **Features**

- High junction temperature capability
- · Low forward voltage drop
- Low recovery charges
- Reduces conduction, reverse and switching losses
- Avalanche tested
- ECOPACK2 compliant



- DC/DC converter
- LED lighting
- Flyback topology
- Auxiliary power supply
- Switch mode power supply (SMPS)



### Product label



### **Description**

This 5 A, 100 V rectifier is based on ST trench technology that achieves the best-inclass  $V_F/I_R$  trade-off for a given silicon surface.

Integrated in a DPAK package, this STPST5H100SB trench rectifier is intended to be used in high frequency miniature switched mode power supplies. It is also an ideal candidate for auxiliary power supply in telecom, server, or smart metering. ST trench rectifiers are adapted to freewheeling, OR-ring or reverse polarity protection applications, and can be the perfect companion device to our transistors, drivers, or ST VIPer products.

### Product status link

STPST5H100SB

Product summary			
I <sub>F(AV)</sub>	5 A		
V <sub>RRM</sub>	100 V		
T <sub>j</sub> (max.)	175 °C		
V <sub>F</sub> (typ.)	0.550 V		



### 1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified, with 2 anode terminals short-circuited)

Symbol	Parameter	Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage		100	V
I <sub>F(RMS)</sub>	Forward rms current	Forward rms current		
I <sub>F(AV)</sub>	Average forward current, $\delta$ = 0.5 square wave $T_c$ = 165 °C		5	Α
I <sub>FSM</sub>	urge non repetitive forward current $t_p$ = 10 ms sinusoidal		150	Α
I <sub>AS</sub>	Single pulse avalanche current <sup>(1)</sup> $ T_j = 25^{\circ}\text{C, L} = 300 \ \mu\text{H}, \\ V_{DD} = 15 \ \text{V} $		9	А
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C	
Tj	Maximum operating junction temperature (2)	+175	°C	

<sup>1.</sup> Please refer to Figure 1 and Figure 2 for the unclamped inductive switching test circuit, and waveform.

Table 2. Thermal resistance parameter

Symbol	Parameter	Typ. value	Unit
$R_{th(j-c)}$	Junction to case	1.3	°C/W

For more information, please refer to the following application note:

AN5088: Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test co	Min.	Тур.	Max.	Unit	
		T <sub>j</sub> = 125 °C	V <sub>R</sub> = 70 V	-	1.0	3.2	mA
I <sub>R</sub> <sup>(1)</sup>	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = 100 V	-		11.5	μA
	T <sub>j</sub> = 125 °C	VR = 100 V	-	2.0	6.5	mA	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 2.5 A	-	0.525	0.575	V
	Forward voltage drop	T <sub>j</sub> = 125 °C	IF - 2.5 A	-	0.450	0.510	
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 5 A	-	0.620	0.685	
		T <sub>j</sub> = 125 °C	IF - 2 V	-	0.550	0.600	

<sup>1.</sup> Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2%

To evaluate the conduction losses, use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.036 \times I_{F}^{2}_{(RMS)}$$

For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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<sup>2.</sup>  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%



Figure 1. Current and voltage waveforms for avalanche energy test across D.U.T (device under test)

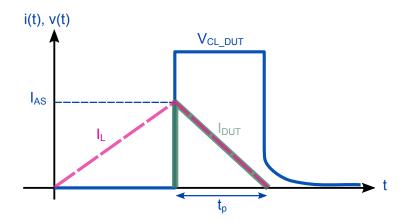
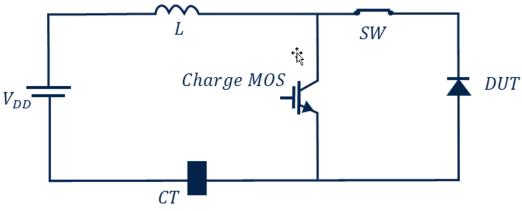


Figure 2. Unclamped inductive switching test circuit



Current monitor

$$\begin{split} E_{AS} &= \frac{1}{2} \times L \times I_{AS}^2 \times \left( \frac{V_{CLDUT}}{V_{CLDUT} - V_{DD}} \right) \cong \frac{1}{2} \times L \times I_{AS}^2 \\ t_p &= \left( \frac{L \times I_{AS}}{V_{CLDUT} - V_{DD}} \right) \end{split}$$

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#### **Characteristics (curves)** 1.1

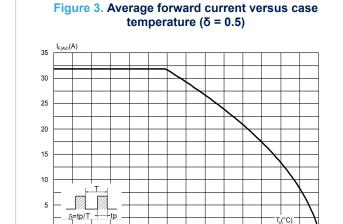


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration 1.0 0.9 0.8 0.7 0.5 0.4 0.3 0.2

Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

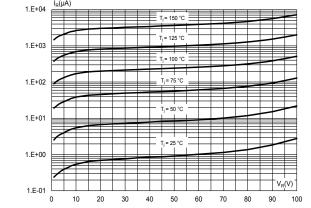


Figure 6. Junction capacitance versus reverse voltage applied (typical values)

1.E-02

1.E-03

1.E-04

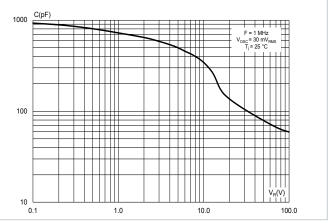


Figure 7. Forward voltage drop versus forward current (typical values)

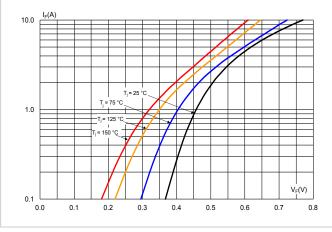
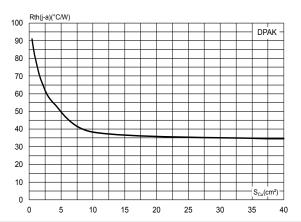


Figure 8. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4, e<sub>Cu</sub>= 70 μm)



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## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 2.1 DPAK package information

Epoxy meets UL94, V0

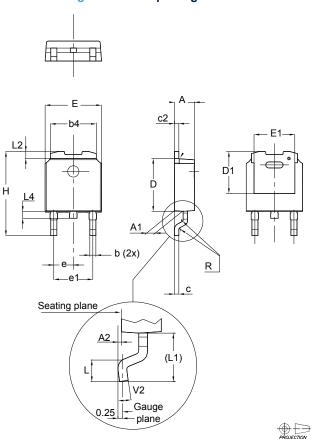


Figure 9. DPAK package outline

Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are quaranteed.

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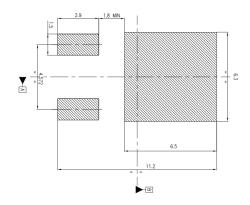


Table 4. DPAK mechanical data

	Dimensions					
Dim.	Millimeters			Inches <sup>(1)</sup>		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.20		2.40	0.087		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	5.20		5.40	0.205		0.213
С	0.45		0.60	0.018		0.024
c2	0.48		0.60	0.019		0.024
D	6.00		6.20	0.236		0.244
D1	4.95	5.10	5.25	0.195	0.201	0.207
Е	6.40		6.60	0.252		0.260
E1	4.60	4.70	4.80	0.181	0.185	0.189
е	2.159	2.286	2.413	0.085	0.090	0.095
e1	4.445	4.572	4.699	0.175	0.180	0.185
Н	9.35		10.10	0.368		0.398
L	1.00		1.50	0.039		0.059
(L1)	2.60	2.80	3.00	0.102	0.110	0.118
L2	0.65	0.80	0.95	0.026	0.031	0.037
L4	0.60		1.00	0.024		0.039
R		0.20			0.008	
V2	0°		8°	0°		8°

<sup>1.</sup> Inches dimensions given for reference only

Figure 10. DPAK recommended footprint (dimensions are in mm)



Note: For package and tape orientation, reel and inner box dimensions and tape outline please check TN1173

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# 3 Ordering information

### Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPST5H100SB-TR	STPST 5H1	DPAK	0.32 g	2500	Tape and reel

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## **Revision history**

Table 6. Document revision history

Date	Revision	Changes
16-Dec-2022	1	Initial release.
21-Jul-2023	2	Updated Features.

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